

Qualification of New Adhesive Material and Molding Compound for Select LFCSP Packages

Detailed Change Description

Qualification of New Adhesive Material and Molding Compound for Select LFCSP Packages

► For NiPdAu-Plating lead frame

BOM	Current	Newly added
Adhesive	Hitachi 4900GC	/
Molding Compound	Hitachi CEL 9220HF13	Hitachi CEL 9240HF10

Qualification of New Adhesive Material and Molding Compound for Select LFCSP Packages

► For Ag-plating lead frame

BOM	Current	Newly added
Adhesive	Ablestik 8290	Hitachi 4900GC
Molding Compound	Sumitomo G770	Sumitomo G700LA